

- Precision UHF SAW Filter
- 3.8 x 3.8 x 1.2 mm Surface-mount Case
- Differential 750 ohm In, 900 ohm Out
- Complies with Directive 2002/95/EC (RoHS)

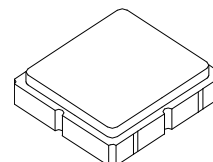


Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Maximum DC Voltage Between any Two Terminals	30	VDC
Storage Temperature Range	-40 to +85	°C
Suitable for Lead-free Soldering - Maximum Soldering Profile	260 °C for 30 s	

SF2110D

**305.00 MHz
SAW Filter**



SM3838-8

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Center Frequency	fC	1		305		MHz
Insertion Loss	IL			9	12	dB
Amplitude Ripple, 300 to 310 MHz		1, 2		0.7	2.0	dB _{P-P}
Low Side Attenuation, 266 to 290 MHz			35	45		dB
High Side Attenuation, 320 to 344 MHz			35	50		
Delay Ripple, 300 to 310 MHz		1, 2, 3		30	100	ns _{P-P}
Group Delay in Passband					500	ns
Case Style		6	SM3838-8 3.8 x 3.8 mm Nominal Footprint			
Lid Symbolization, Y=year, WW=week, S=shift			608 YWWS			

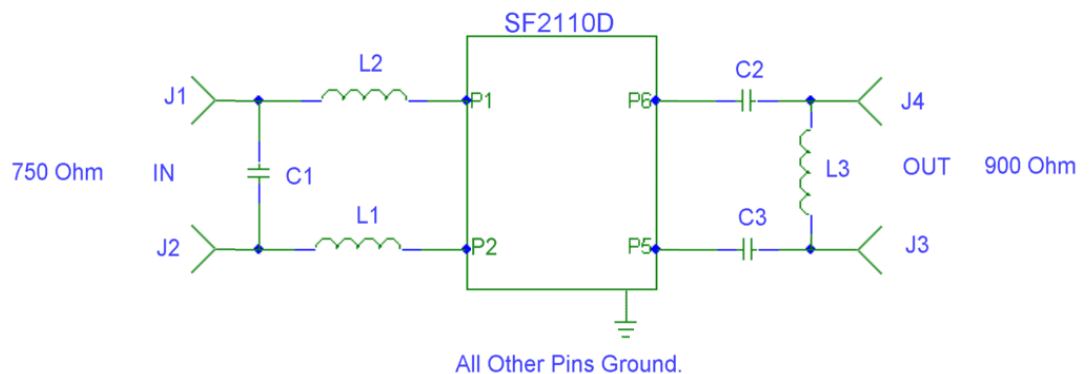


CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

NOTES:

1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fC.
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. The design, manufacturing process, and specifications of this filter are subject to change.
5. Tape and Reel Standard Per ANSI / EIA 481.
6. US and international patents may apply.
7. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

I. Differential Matching



SF2110D Demo

PCB: 400-1724-001 4 port

J1-J4: 500-1279-001 SMACONN

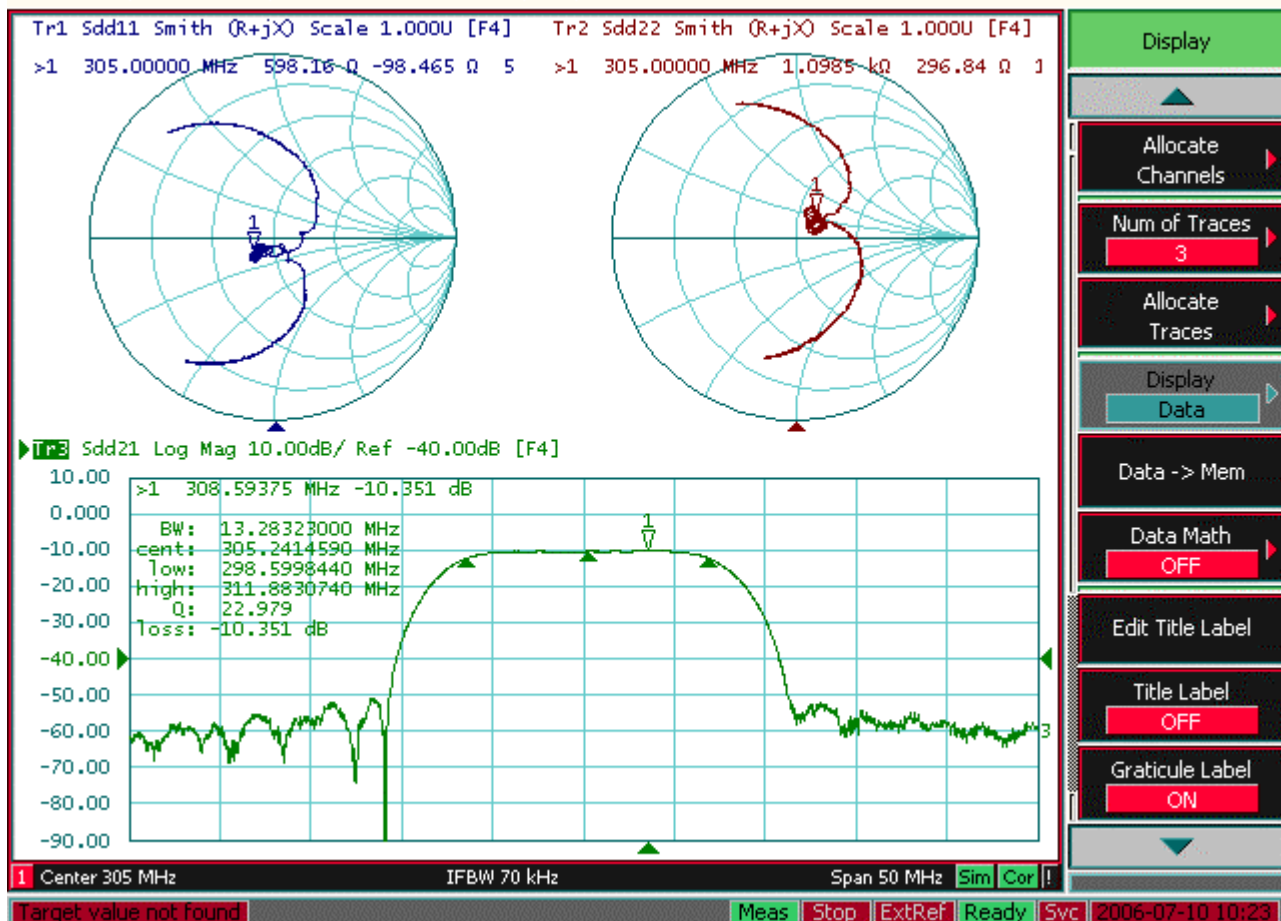
L1-L2: 500-1282-470 47nH 0402

L3: 500-1282-560 56nH 0402

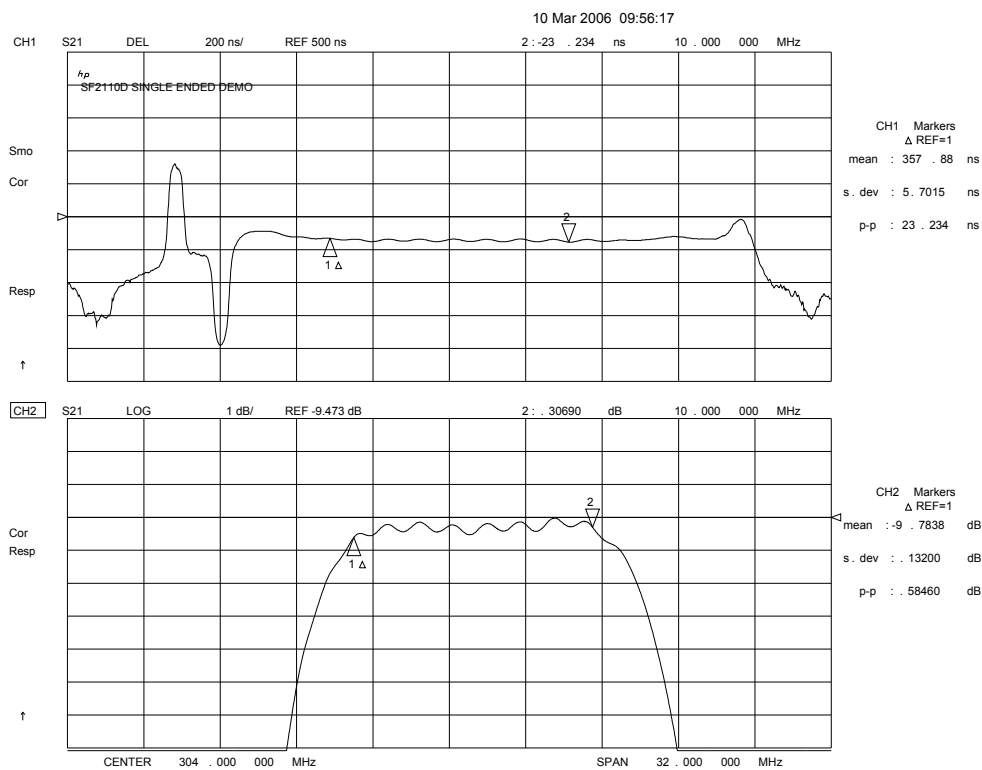
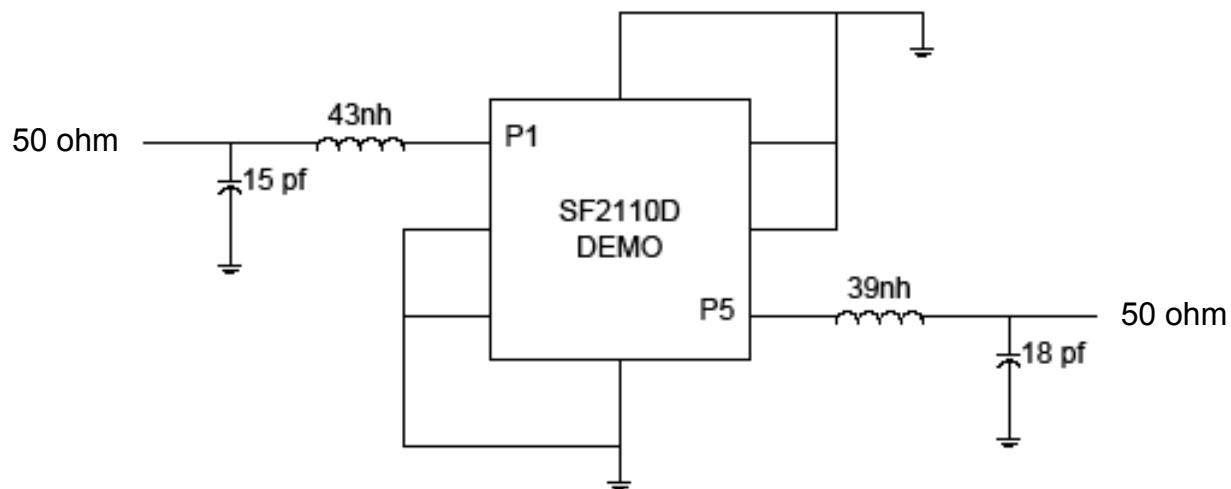
C1: 501-0857-047 4.7pF 0402

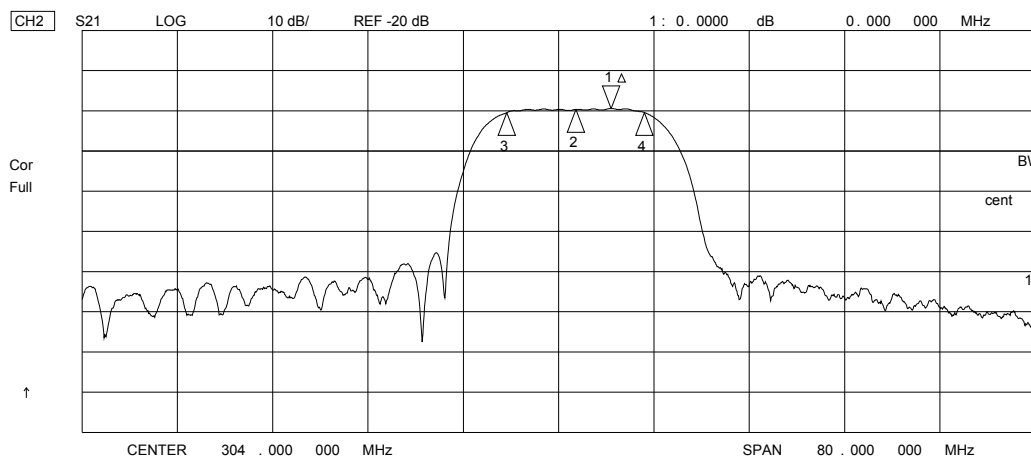
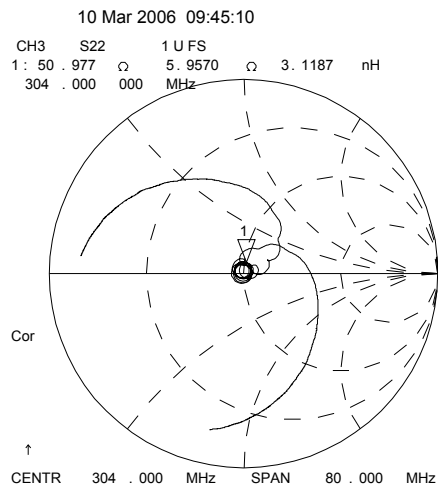
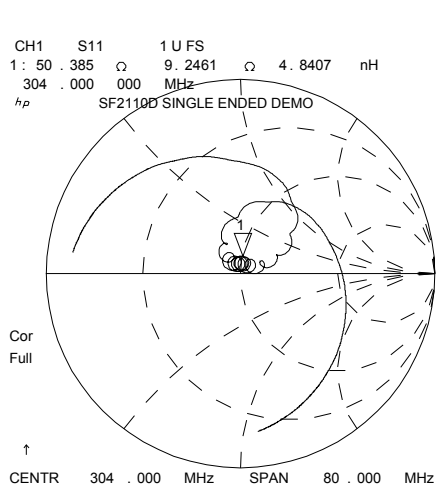
C2: 501-0857-180 18pF 0402

C3: 501-0857-220 22pF 0402



II. Single-ended Matching



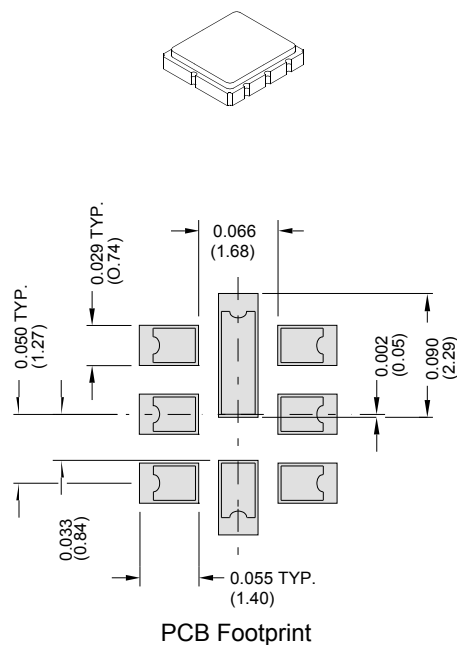


CH2 Markers
Max Δ REF=1
BW: 11.548530 MHz
cent: 305.440946 MHz
Q: 26.448
1 loss: -9.4651 dB

SM3838-8 Case

8-Terminal Ceramic Surface-Mount Case

3.8 X 3.8 mm Nominal Footprint



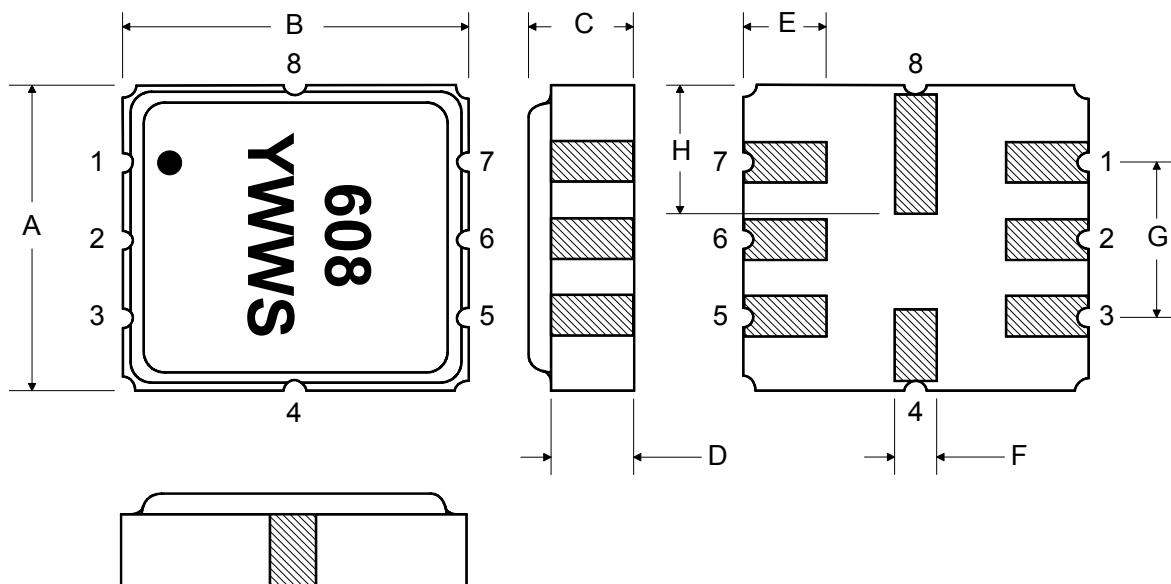
Case Dimensions						
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	3.6	3.8	4.0	0.142	0.150	0.157
B	3.6	3.8	4.0	0.142	0.150	0.157
C	1.05	1.20	1.35	0.041	0.047	0.053
D	0.95	1.10	1.25	0.037	0.043	0.049
E	0.90	1.00	1.10	0.035	0.040	0.043
F	0.50	0.60	0.70	0.020	0.024	0.028
G	2.39	2.54	2.69	0.090	0.100	0.110
H	1.40	1.75	2.05	0.055	0.069	0.080

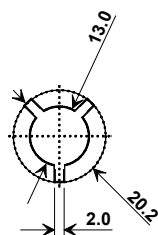
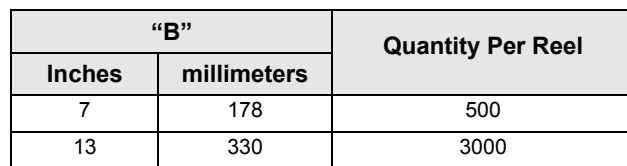
Electrical Connections		
	Connection	Terminals
Port 1	Differential Input	1, 2
Port 2	Differential Output	5, 6
	Ground	All Others
Single-ended Operation		Return is Ground
Differential Operation		Return is Hot
Dot Indicates Pin 1		

Materials	
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel
Lid Plating	2.0 to 3.0 μm Nickel
Body	Al_2O_3 Ceramic
Pb Free	

TOP VIEW

BOTTOM VIEW





COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	4.25 mm
Bo	4.25 mm
Ko	1.6 mm
Pitch	8.0 mm
W	12.0 mm

